DESCRIPTION

The SPN2318W is the N-Channel logic enhancement mode power field effect transistors are produced using high cell density, DMOS trench technology.

This high density process is especially tailored to minimize on-state resistance.

These devices are particularly suited for low voltage application such as cellular phone and notebook computer power management and other battery powered circuits, and low in-line power loss are needed in a very small outline surface mount package.

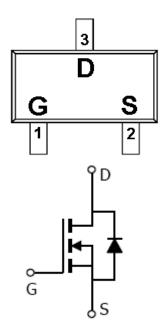
APPLICATIONS

- Power Management in Note book
- Portable Equipment
- Battery Powered System
- DC/DC Converter
- Load Switch
- DSC
- LCD Display inverter

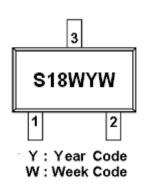
FEATURES

- 40V/3.9A, RDS(ON)= $56m\Omega$ @VGS=10V
- 40V/3.5A,RDS(ON)= $62m\Omega$ @VGS=4.5V
- 40V/2.0A,RDS(ON)= $95m\Omega$ @VGS=2.5V
- ◆ Super high density cell design for extremely low RDS(ON)
- Exceptional on-resistance and maximum DC current capability
- ◆ SOT-23 package design

PIN CONFIGURATION (SOT-23)



PART MARKING



PIN DESCRIPTION						
Pin	Symbol	Description				
1	G	Gate				
2	S	Source				
3	D	Drain				

ORDERING INFORMATION

Part Number	Package	Part Marking
SPN2318WS23RGB	SOT-23	S18W

% Week Code : A ~ Z(1 ~ 26); a ~ z(27 ~ 52)

※ SPN2318WS23RGB: Tape Reel; Pb − Free; Halogen -Free

ABSOULTE MAXIMUM RATINGS

(TA=25°C Unless otherwise noted)

Parameter		Symbol	Typical	Unit	
Drain-Source Voltage		Vdss	40	V	
Gate –Source Voltage		VGSS	±12	V	
Continuous Dusin Cumont/Tr-1509C)	Ta=25°C	In	4.0	Δ.	
Continuous Drain Current(T _J =150°C)	Ta=70°C	- Id	3.0	A	
Pulsed Drain Current		Ірм	10	A	
Continuous Source Current(Diode Conduction)		Is	1.25	A	
Downey Dissipation	Ta=25°C	PD	1.25	W	
Power Dissipation	Ta=70°C		0.8	W	
Operating Junction Temperature		TJ	150	°C	
Storage Temperature Range		Tstg	-55/150	°C	
Thermal Resistance-Junction to Ambient		R _θ JA	100	°C/W	

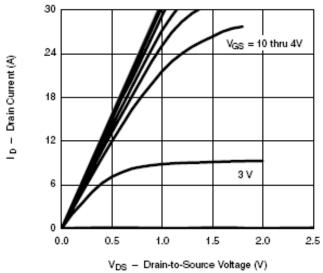
ELECTRICAL CHARACTERISTICS

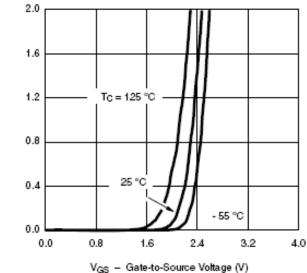
(TA=25°C Unless otherwise noted)

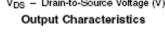
Parameter	Symbol	Conditions	Min.	Тур	Max.	Unit
Static	I		I	ı	ı	
Drain-Source Breakdown Voltage	V(BR)DSS	VGS=0V,ID=250uA	D=250uA 40			7.7
Gate Threshold Voltage	VGS(th)	VDS=VGS,ID=250uA	0.5		1.2	V
Gate Leakage Current	Igss	$V_{DS}=0V,V_{GS}=\pm 12V$			±100	nA
Zero Gate Voltage Drain Current		VDS=40V,VGS=0V			1	uA
	Idss	V _{DS} =40V,V _{GS} =0V T _J =85°C			5	
On-State Drain Current	ID(on)	VDS=5V,VGS =4.5V	10			A
		Vgs=10V,Id=3.9A		0.050	0.056	Ω
Drain-Source On-Resistance	RDS(on)	Vgs=4.5V,Id=3.5A		0.056	0.062	
		Vgs=2.5V,Id=2.0A		0.088	0.095	
Forward Transconductance	gfs	VDS=15V,ID=6.2A		13		S
Diode Forward Voltage	Vsd	Is=2.3A,VGS =0V		0.8	1.2	V
Dynamic						
Total Gate Charge	Qg			10	15	nC
Gate-Source Charge	Qgs	V _{DS} =15V,V _{GS} =10V I _D =2A		1.6		
Gate-Drain Charge	Qgd	ID-ZA		2.0		
Input Capacitance	Ciss			500		pF
Output Capacitance	Coss	VDS=20V,VGS=0V -f=1MHz		80		
Reverse Transfer Capacitance	Crss			45		
Turn-On Time	td(on)			15	20	nS
	tr	VDD=15V,RL=15 Ω		6	12	
Turn-Off Time	td(off)	ID=1.0A,VGEN=10V RG= 6Ω		10	20	
	tf			40	80	

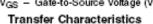
I D - Drain Current (A)

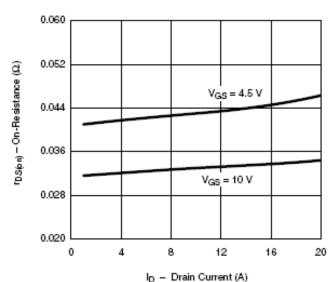
TYPICAL CHARACTERISTICS

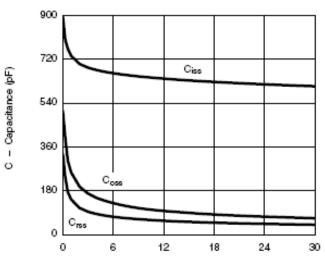










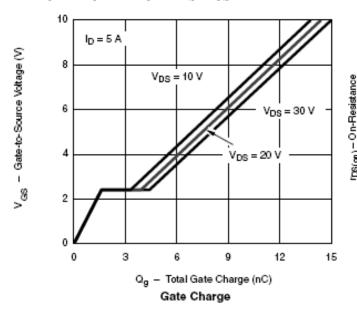


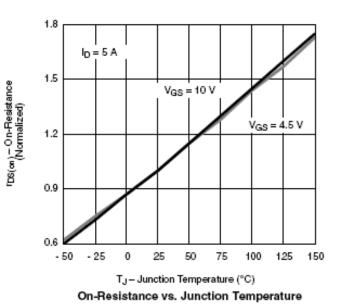
On-Resistance vs. Drain Current and Gate Voltage

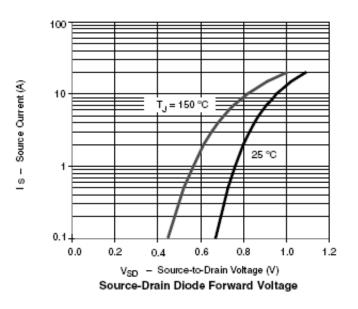
V_{DS} - Drain-to-Source Voltage (V)

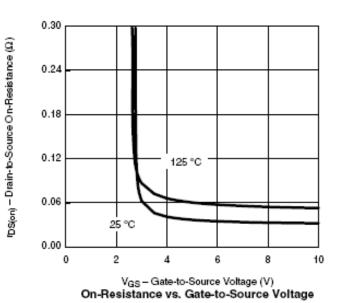
Capacitance

TYPICAL CHARACTERISTICS



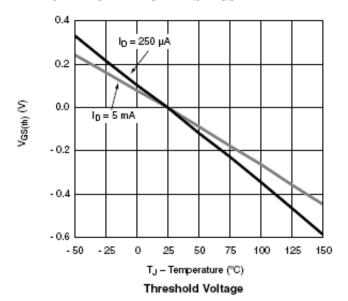


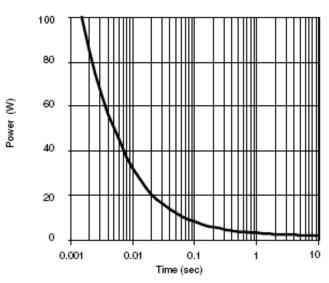




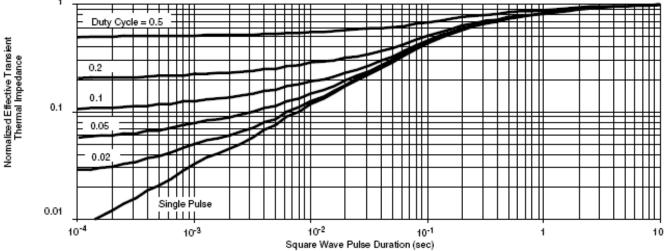
N-Channel Enhancement Mode MOSFET

TYPICAL CHARACTERISTICS





Single Pulse Power, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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